

US00D893433S

(12) **United States Design Patent**
Adams et al.(10) **Patent No.:** US D893,433 S
(45) **Date of Patent:** ** Aug. 18, 2020(54) **ELECTRICAL INTERCONNECT CAPSULE**(71) Applicants: **Lynwood Adams**, Rockwall, TX (US);
Jack Lewis, Royse City, TX (US)(72) Inventors: **Lynwood Adams**, Rockwall, TX (US);
Jack Lewis, Royse City, TX (US)(73) Assignee: **MODUS TEST, LLC**, Richardson, TX
(US)(**) Term: **15 Years**(21) Appl. No.: **29/683,835**(22) Filed: **Mar. 15, 2019**(51) LOC (12) Cl. **13-03**

(52) U.S. Cl.

USPC **D13/146**(58) **Field of Classification Search**USPC D13/103, 107, 108, 110, 112, 118, 120,
D13/123, 133, 137.1, 145–147, 149–156,
D13/158, 173, 177, 184, 199, 242;

D14/240, 242, 433, 434, 435.1, 438

CPC H01L 21/67271; G01R 31/2893

See application file for complete search history.

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Primary Examiner — Darcey E Gottschalk(74) *Attorney, Agent, or Firm* — Christopher A. Proskey;
BrownWinick Law Firm(57) **CLAIM**

The ornamental design for an electrical interconnect capsule, as is shown and described.

DESCRIPTION

FIG. 1 is a top perspective view of an electrical interconnect capsule,

FIG. 2 is a bottom perspective view of an electrical interconnect capsule,

FIG. 3 is a front elevation view of an electrical interconnect capsule,

FIG. 4 is a rear elevational view of an electrical interconnect capsule,

FIG. 5 is a right elevational view of an electrical interconnect capsule,

FIG. 6 is a left elevation view of an electrical interconnect capsule,

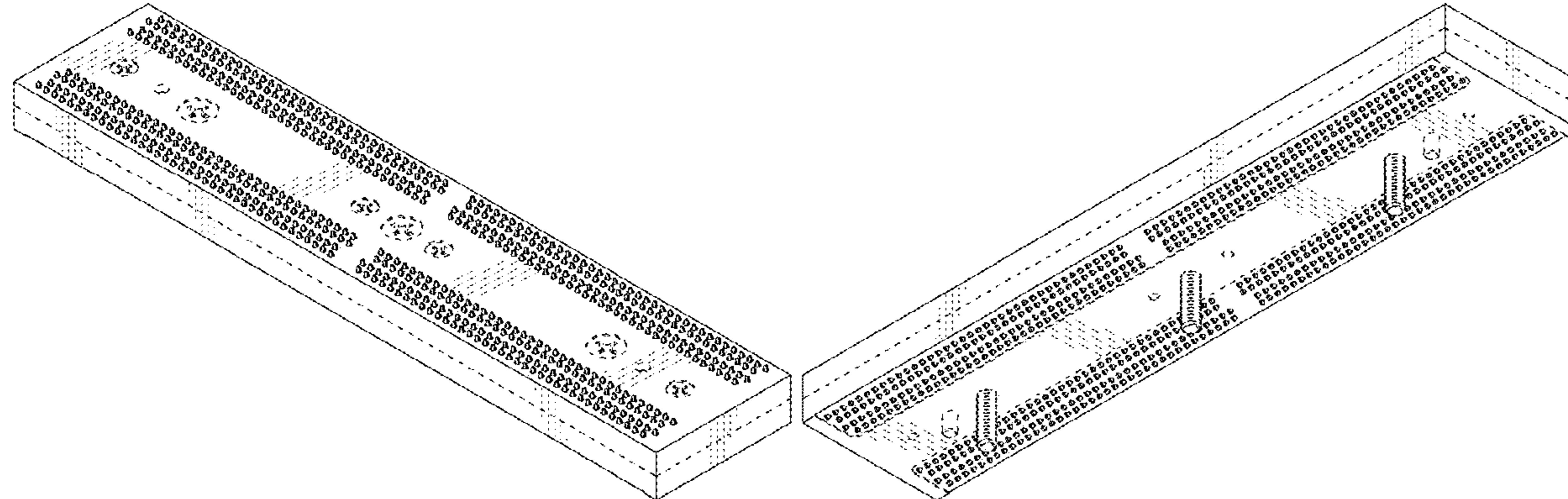
FIG. 7 is a top elevation view of an electrical interconnect capsule,

FIG. 8 is a bottom elevation view of an electrical interconnect capsule,

FIG. 9 is a close up perspective view of a portion of the top side of an electrical interconnect capsule; and,

FIG. 10 is a close up perspective view of a portion of the bottom side of an electrical interconnect capsule.

The dashed lines shown represent the environment and represent unclaimed subject matter and form no part of the claimed design.

1 Claim, 10 Drawing Sheets

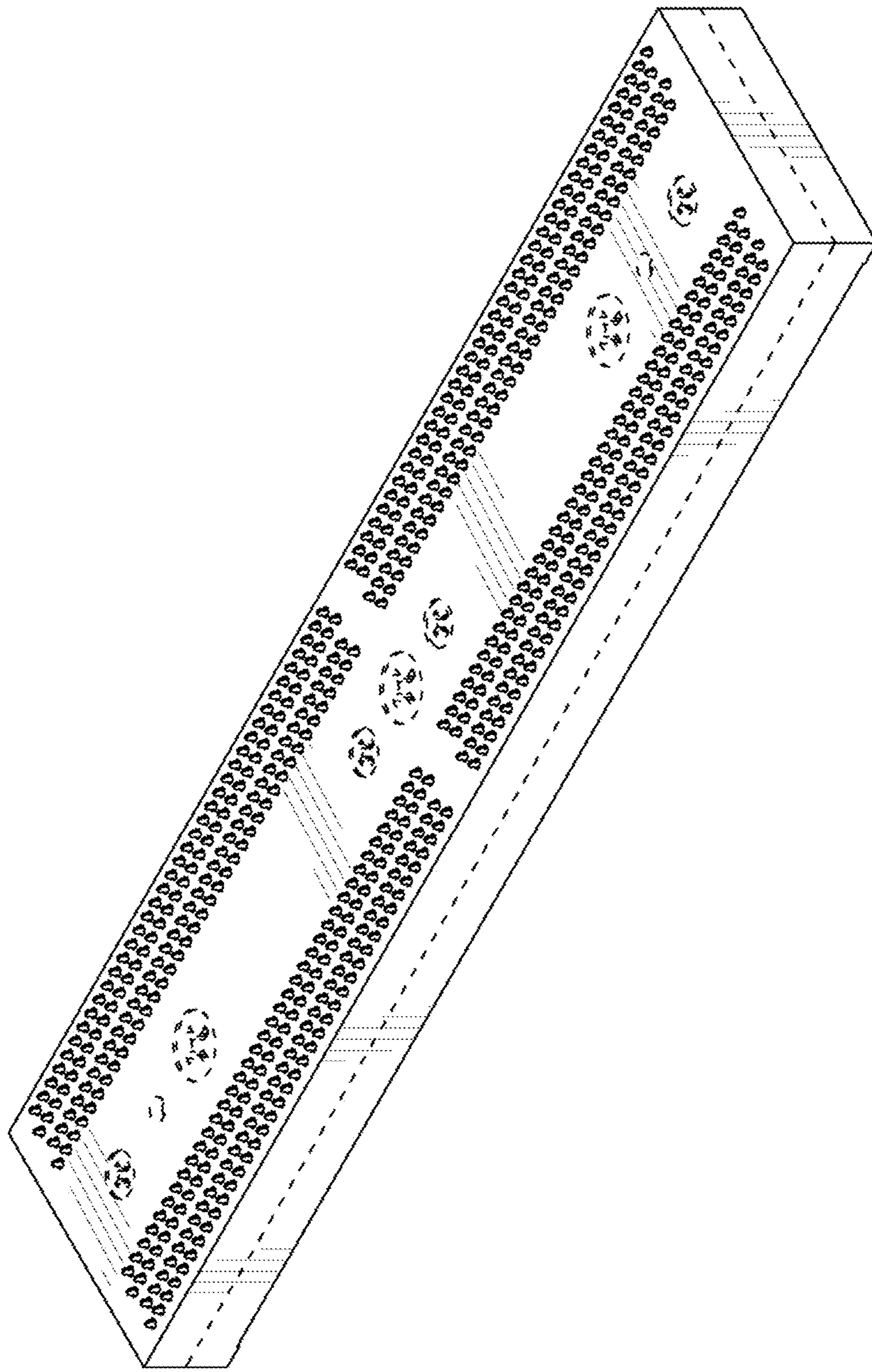


FIG. 1

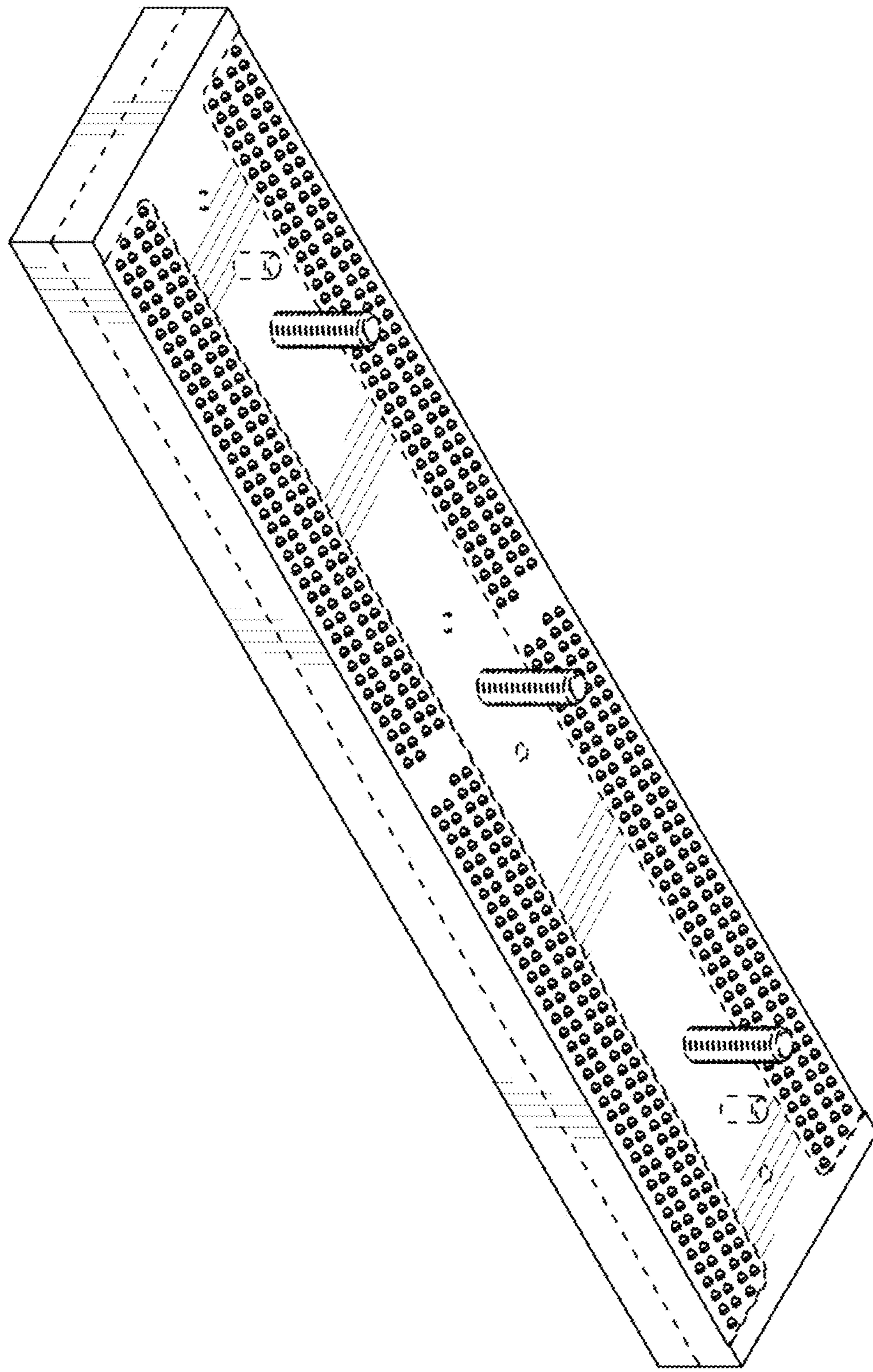
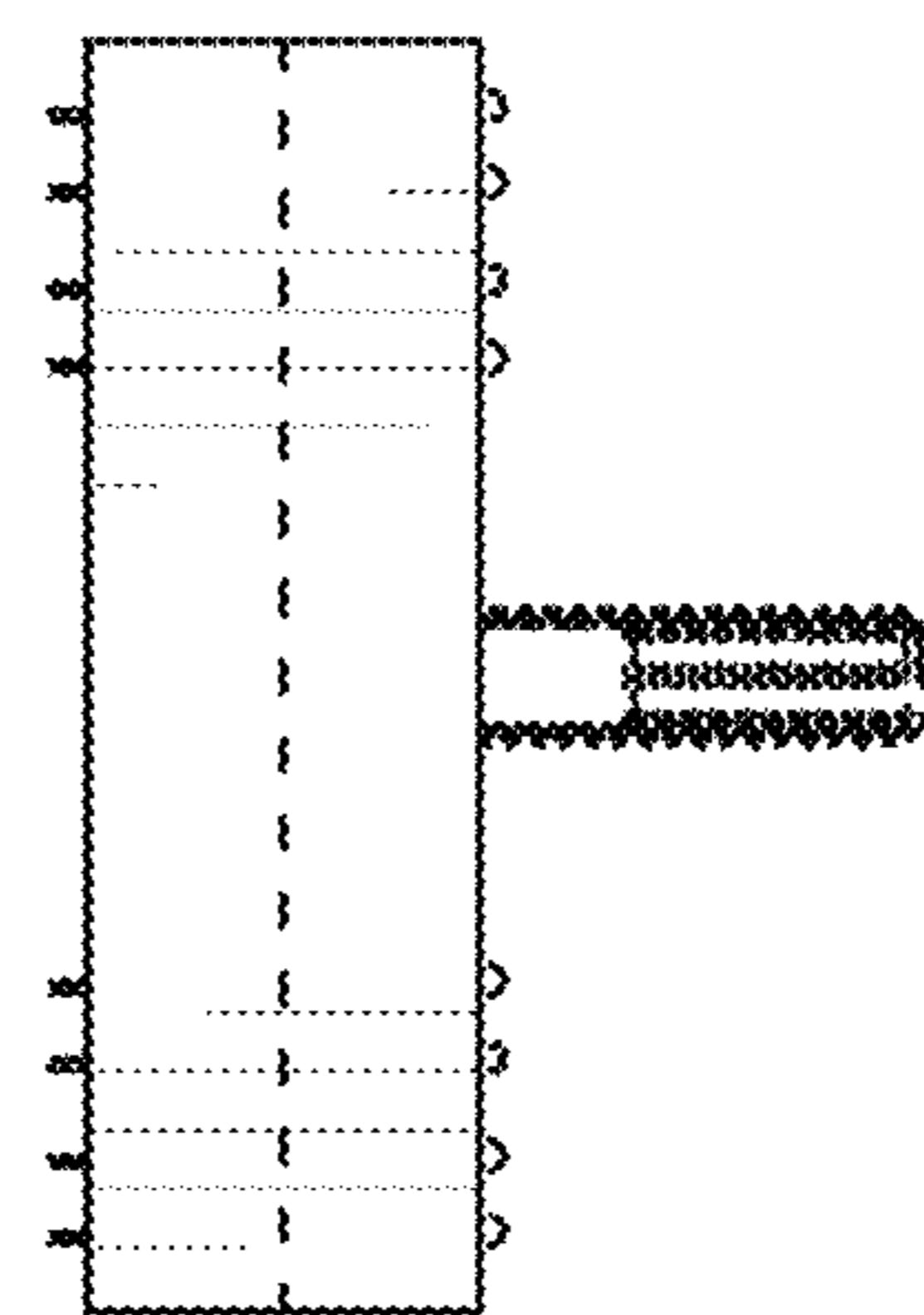


FIG. 2



**FIG.
E**

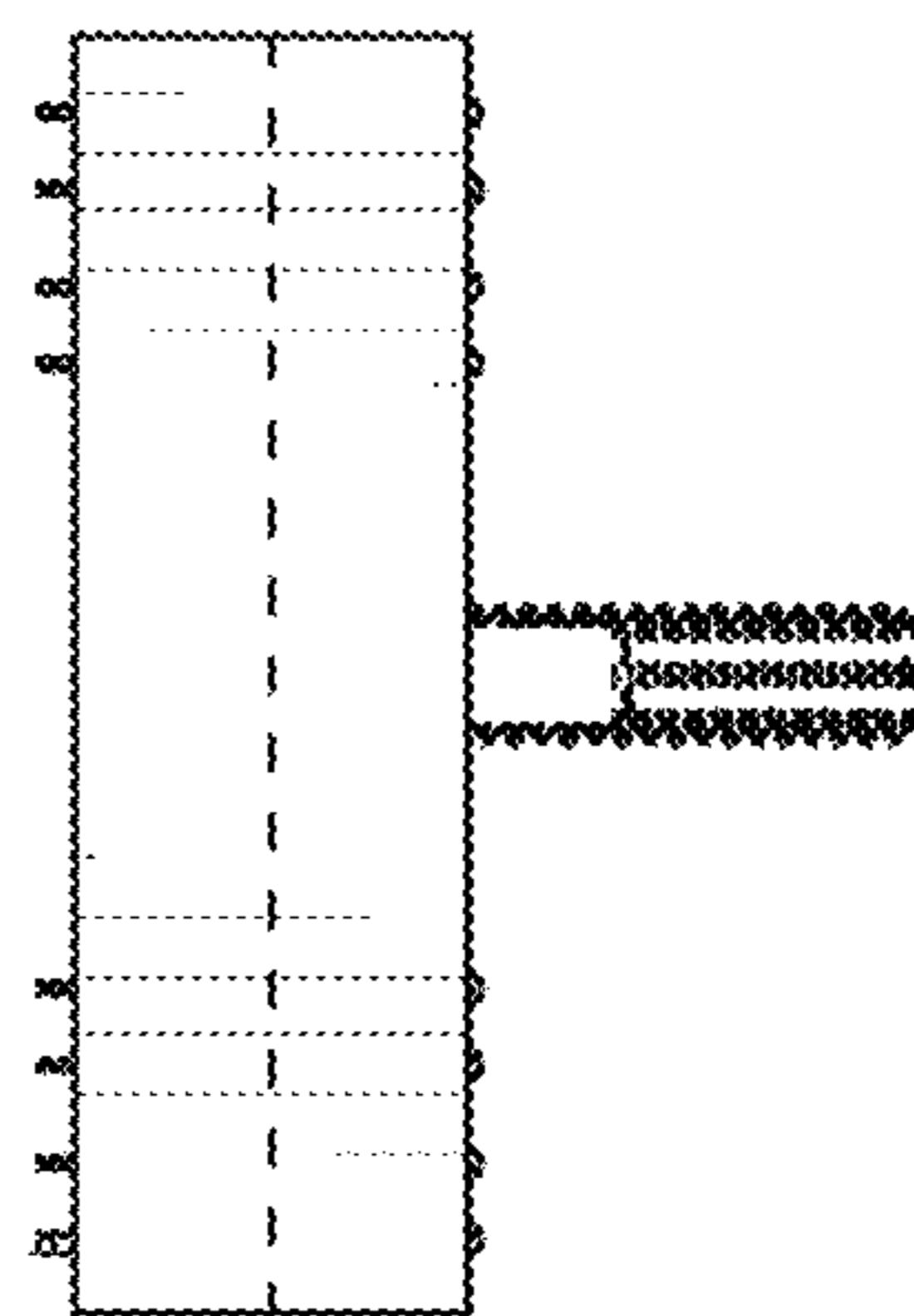


FIG. 4

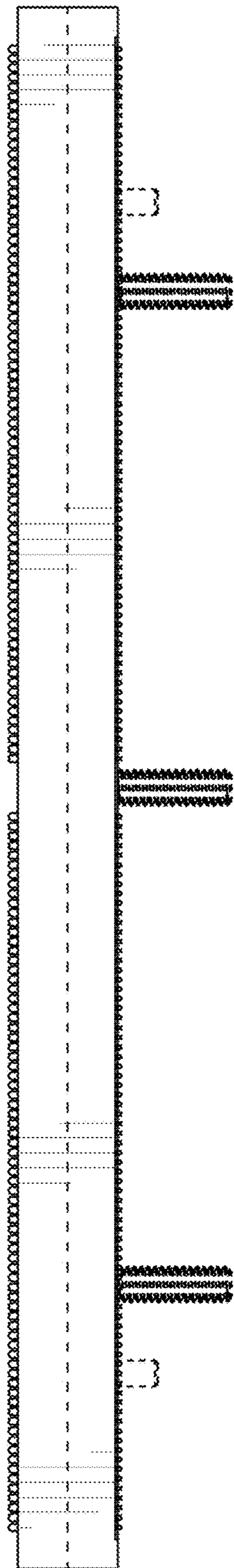


FIG. 5

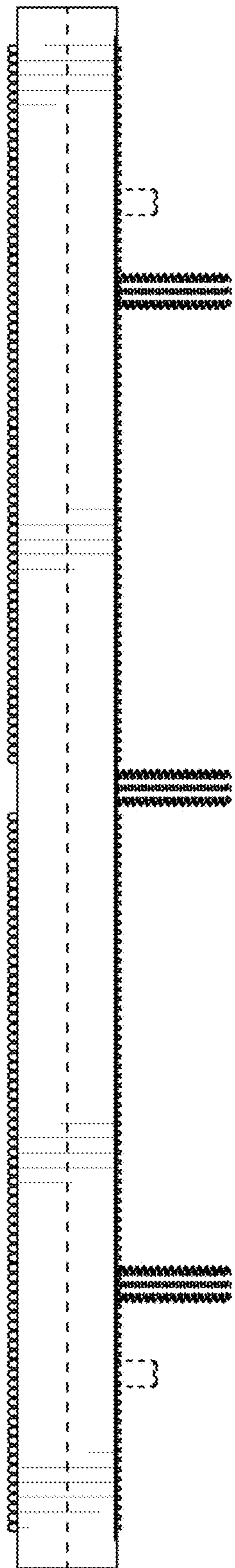


FIG. 6

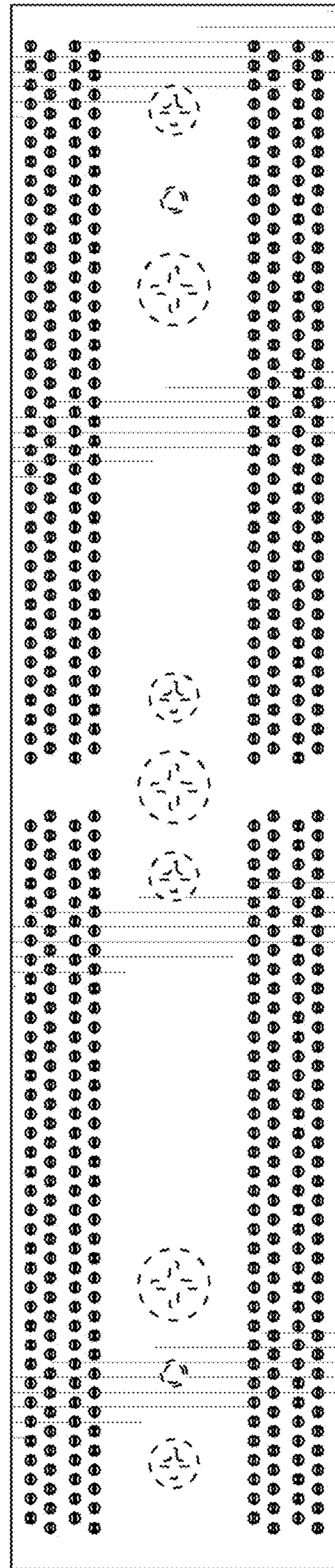


FIG. 7

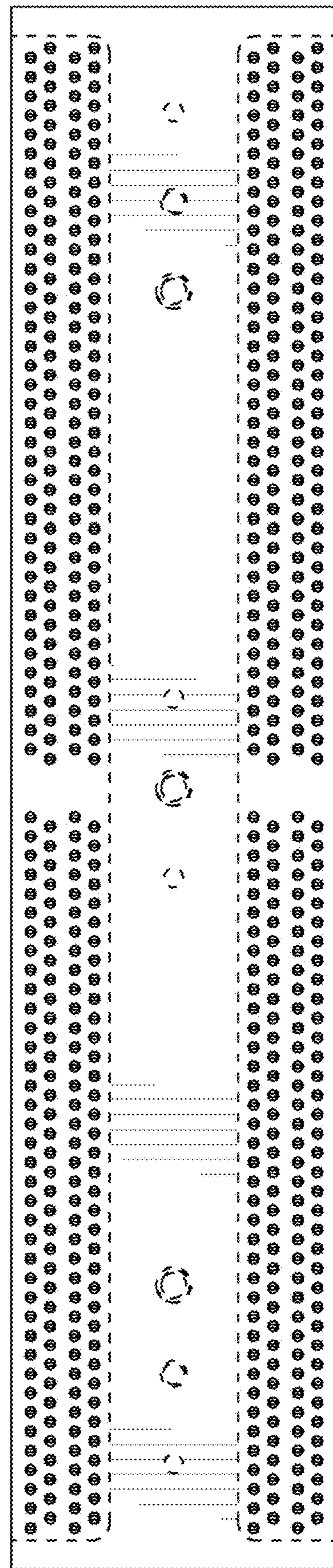


FIG. 8

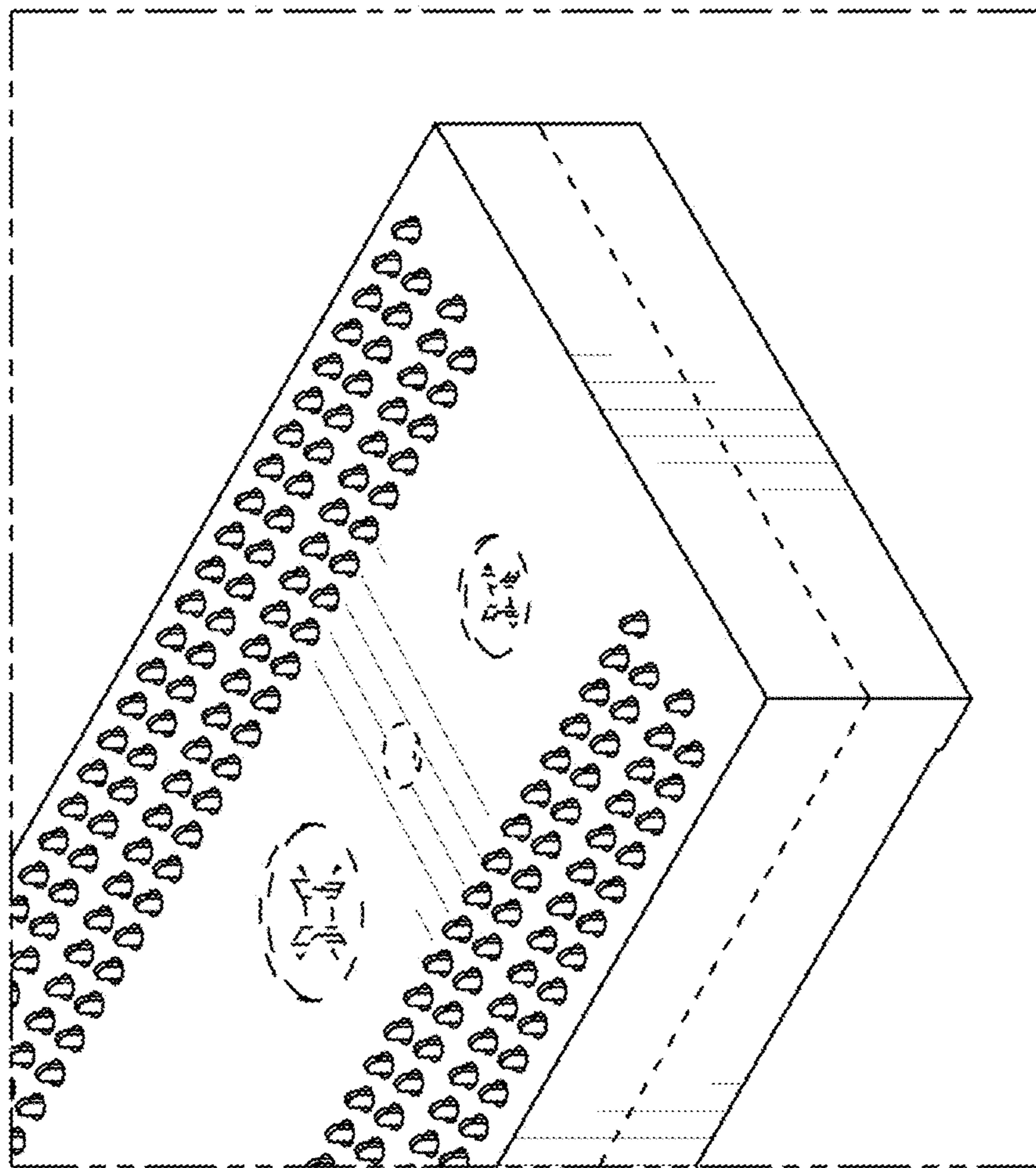


FIG. 9

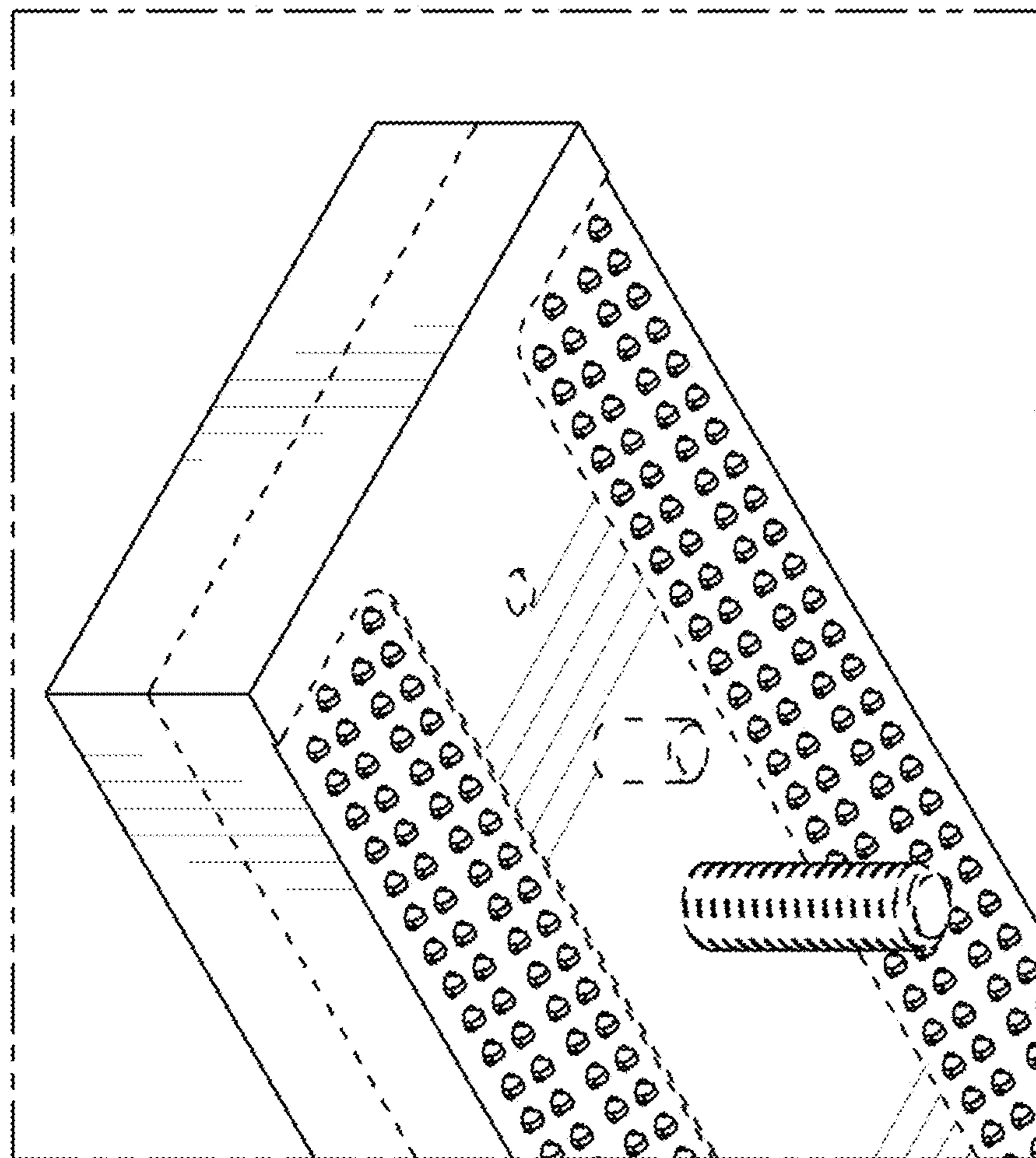


FIG. 10